

# 2SC1383, 2SC1384

## Silicon NPN epitaxial planer type

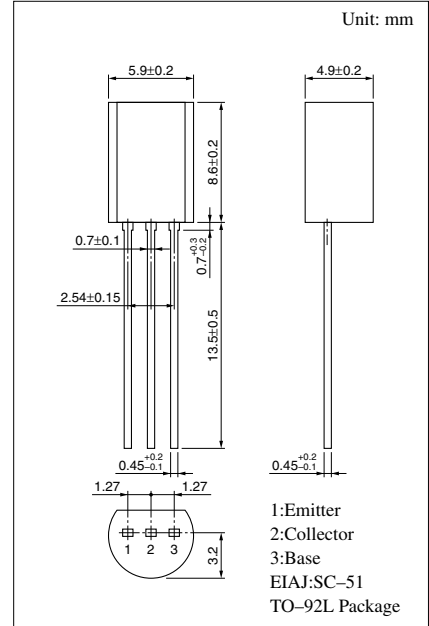
For low-frequency power amplification and driver amplification  
Complementary to 2SA0683 (2SA683) and 2SA0684 (2SA684)

### Features

- Low collector to emitter saturation voltage  $V_{CE(sat)}$
- Complementary pair with 2SA0683 and 2SA0684.

### Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rated	Unit
Collector to base voltage	$V_{CBO}$	30	V
Collector to emitter voltage		60	
Collector to emitter voltage	$V_{CEO}$	25	V
Emitter to base voltage		50	
Emitter to base voltage	$V_{EBO}$	5	V
Peak collector current	$I_{CP}$	1.5	A
Collector current	$I_C$	1	A
Collector power dissipation	$P_C$	1	W
Junction temperature	$T_j$	150	°C
Storage temperature	$T_{stg}$	-55 ~ +150	°C



### Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	$I_{CBO}$	$V_{CB} = 20V, I_E = 0$			0.1	$\mu A$
Collector to base voltage	$V_{CBO}$	$I_C = 10\mu A, I_E = 0$	30			V
			60			
Collector to emitter voltage	$V_{CEO}$	$I_C = 2mA, I_B = 0$	25			V
			50			
Emitter to base voltage	$V_{EBO}$	$I_E = 10\mu A, I_C = 0$	5			V
Forward current transfer ratio	$h_{FE1}^{*1}$	$V_{CE} = 10V, I_C = 500mA^{*2}$	85	160	340	
	$h_{FE2}$	$V_{CE} = 5V, I_B = 1A^{*2}$	50	100		
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = 500mA, I_B = 50mA^{*2}$		0.2	0.4	V
Base to emitter saturation voltage	$V_{BE(sat)}$	$I_C = 500mA, I_B = 50mA^{*2}$		0.85	1.2	V
Transition frequency	$f_T$	$V_{CB} = 10V, I_E = -50mA, f = 200MHz$		200		MHz
Collector output capacitance	$C_{ob}$	$V_{CB} = 10V, I_E = 0, f = 1MHz$		11	20	pF

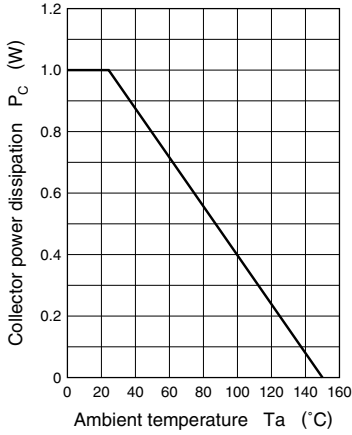
\*2 Pulse measurement

\*1  $h_{FE1}$  Rank classification

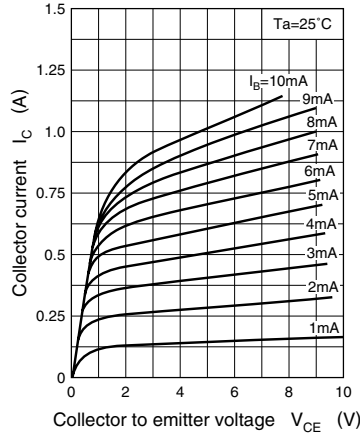
Rank	Q	R	S
$h_{FE1}$	85 ~ 170	120 ~ 240	170 ~ 340

Note.) The Part numbers in the Parenthesis show conventional part number.

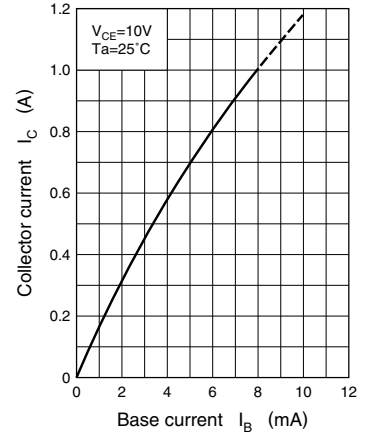
$P_C - T_a$



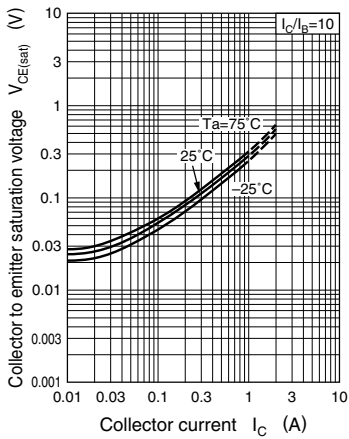
$I_C - V_{CE}$



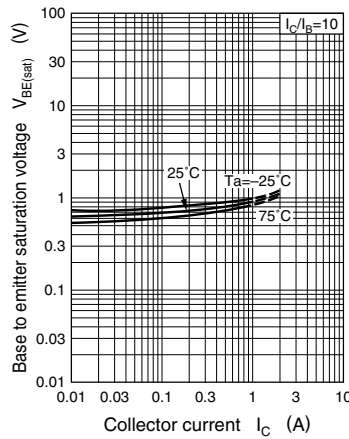
$I_C - I_B$



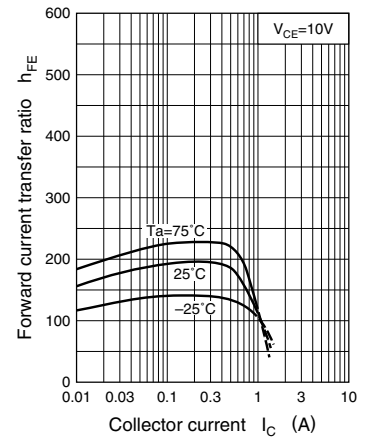
$V_{CE(sat)} - I_C$



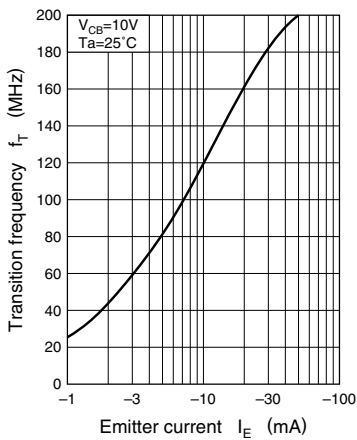
$V_{BE(sat)} - I_C$



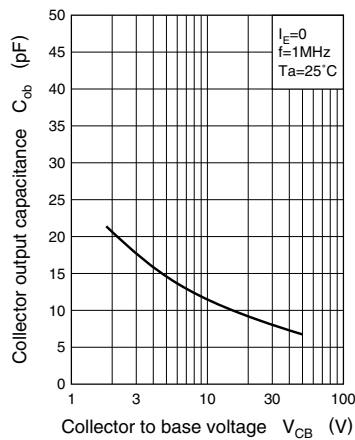
$h_{FE} - I_C$



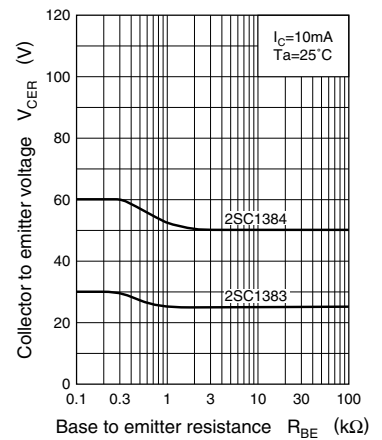
$f_T - I_E$



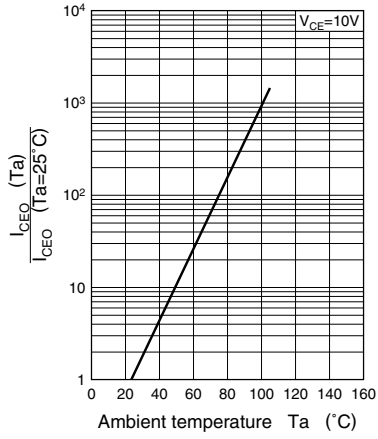
$C_{ob} - V_{CB}$



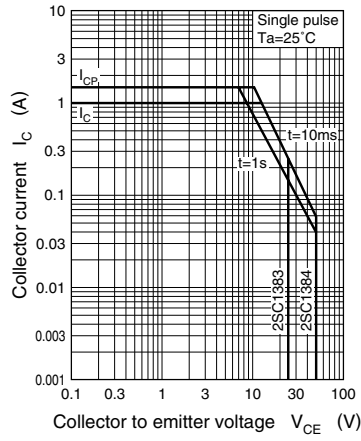
$V_{CER} - R_{BE}$



$I_{CEO} - T_a$



Area of safe operation (ASO)



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